Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S23	789825	polyimide polyamide thermo\$plastic	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 10:52
S25	1349046	flexible	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 10:53
S24	1311931	adhere adhesive	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 10:53
S27	548592	wiring .	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 10:54
S26	24472	MCM (multi near chip near module) (multi\$1chip near module) (multi\$1chip\$1module)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 10:54
S28	730	S23 and S24 and S25 and S26 and S27	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 11:29
S29	964675	fold folded wrap wrapped .	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 11:30
S31	65202	S23 with S24	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 12:28
S30	162	S28 and S29	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 12:28
S32	311	S31 and S25 and S26 and S27	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 12:29
S33	51	S32 and S29	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 12:35

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S35	40	(optically optical) with tweezing	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 12:53
S34		10/528160	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/08/30 12:53
S36	138	("20020005354" "20020045272" "20020058332" "20020094533" "20030032204" "20030047676" "3558877" "3628182" "3638139" "3662183" "3710279" "3725810" "3761721" "3778612" "3793541" "3808432" "3808550" "4063106" "4092535" "4127329" "4247815" "4253846" "4327288" "4386274" "4390403" "4440638" "4451412" "4453805" "4520484" "4536657" "4627689" "4632517" "4756427" "4827125" "4886360" "4887721" "4893886" "4908112" "5029791" "5079169" "5100627" "5113286" "5121400" "5170890" "5189294" "5198369" "5206504" "5212382" "5245466" "5274231" "5283417" "5308976" "5327515" "5337324" "5338930" "5343038" "5355252" "5360764" "5363190" "5364744" "5374566" "5445011" "5452123" "5473471" "5495105" "5512745" "5608519" "5620857" "5625484" "5629802" "5631141" "5637458" "56744588" "5653859" "5760395" "5770856" "5773298" "5776674" "5793485" "5795457" "5804436" "5814200" "5858192" "5888370" "5900160" "5919646" "5935507" "5939716" "5993630" "5993631" "5993632" "6015714" "6033546" "6055106" "6067859" "6071394" "6074725" "6078681" "6082205" "6088097" "6088376" "6096509" "6111398" "61121603" "6139831" "6142025" "6143558" "6149789" "6159749" "6197176" "6208815" "6215134" "6221654").PN. OR ("6224732" "6242209" "6280960" "6280967" "6287758" "62877776" "6288895" "6280860" "6280967" "6287758" "62877776" "6288895" "6509085" "6514722").PN. OR ("6778724").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/08/30 12:59
S70	163	S62 and S63	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
S69	40	(optically optical) with tweezing	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
S68	1	10/528160	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41

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S67	138	("20020005354" "20020045272" "20020058332" "20020094533" "20030032204" "20030047676" "3558877" "3628182" "3638139" "3662183" "3710279" "3725810" "3761721" "3778612" "3793541" "3808432" "3808550" "4063106" "4092535" "4127329" "4247815" "4253846" "4327288" "4386274" "4390403" "4440638" "4451412" "4453805" "4520484" "4536657" "4627689" "4632517" "4756427" "4827125" "4886360" "4887721" "4893886" "4908112" "5029791" "5079169" "5100627" "5113286" "5121400" "5170890" "5189294" "5198369" "5206504" "5212382" "5245466" "5274231" "5283417" "5308976" "5327515" "5337324" "5338930" "5343038" "5355252" "5360764" "5363190" "5364744" "5374566" "5445011" "5452123" "5473471" "5495105" "5512745" "5608519" "560857" "5625484" "5629802" "5631141" "5637458" "5694216" "5719467" "5760395" "5770856" "5773298" "5776674" "5793485" "5900160" "5919646" "5935507" "5939716" "59942443" "6950071" "5993632" "6015714" "6033546" "6082205" "6088097" "6071394" "6074725" "6078681" "6082205" "6088097" "6088376" "6096509" "6111398" "6121603" "6139831" "6142025" "6143558" "6221654").PN. OR ("6224732" "6287832" "6280960" "6280967" "6287758" "6399397" "6488895" "6509085" "6514722").PN. OR ("6778724").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/09/21 10:41
S66	52	S65 and S63	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2006/09/21 10:41
S65	313	S64 and S57 and S58 and S59	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
S64	65545	S61 with S60	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM TDB	OR	ON	2006/09/21 10:41
S62	733	S61 and S60 and S57 and S58 and S59	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
S61	793403	polyimide polyamide thermo\$plastic _	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
S60	1318680	adhere adhesive	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41

S59	551498	wiring	US-PGPUB:	OR	ON	2006/09/21 10:41
	301430	······································	USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB			2000/00/21 10:41
S58	24648	MCM (multi near chip near module) (multi\$1chip near module) (multi\$1chip\$1module)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR ·	ON	2006/09/21 10:41
S57	1356317	flexible	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
S56	5	("5028986").PN	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/09/21 10:41
S55	2	("20060049495").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/09/21 10:41
S54	91	("3555364" "4734825" "5043794" "5148265" "5172303" "5192716" "5286926" "5347159" "5367764" "5371654" "5375041" "5386341" "5394303" "5473119" "5483421" "5548091" "5558928" "5570504" "5583321" "5665473" "5672548" "5682061" "5685885" "5686699" "5734555" "5777379" "5783870" "5794330" "5798564" "5801439" "5848467" "5861666" "5875545" "5901041" "5915170" "5926369" "5929517" "5943213" "5950304" "6108210"). PN. OR ("6376769").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/09/21 10:41
S53	2	("6376769").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/09/21 10:41
S52	9	Echigoya near Masami	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
S51	266	Echigoya	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
\$50	30	("3760090" "3780352" "3888639" "4449769" "4599636" "4817280" "4914259" "4935584" "5004639" "5128831" "5142448" "5239448" "5384691" "5448511" "5508565" "5604379" "5637828" "5776797" "5789815" "5793108" "5804874" "5977640" "6014316" "6084294" "6118176" "6121676" "6208521" "6225688" "6252176" "6300679"). PN. OR ("6977441").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/09/21 10:41
S49	74966	S48 with S41	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41

S48	1665272	flexible folded	US-PGPUB:	OR	ON ·	2006/09/21 10:41
540	1003272		USPAT; EPO; JPO; DERWENT; IBM_TDB	UK	ON .	2000/09/21 10.41
S47	1	("6376769").PN. OR ("6998704").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/09/21 10:41
S46	110	S44 and S45	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2006/09/21 10:41
S45	5334	S37 S38 S39	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
S44	9582	S43 and S42	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
S43	71256	S40 with S41	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
S42	469849	thermo\$1plastic	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
S41	2236780	substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
S40	1356209	flexible	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:41
S39	2282	(257/686).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/09/21 10:41
S38	664	(257/685).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/09/21 10:41
S37	2918	(257/678) CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR .	OFF	2006/09/21 10:41
S71	1657324	fold folded wrap wrapped bent bend	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:45

S63	970210	fold folded wrap wrapped	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:45
S73	3477	S72 same S60	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:46
S72	24359	S61 same S71	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 10:46
S74	40	S73 and S58	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 11:31
S75	42	(("4822451") or ("4879176") or ("5598307") or ("5924187") or ("6248067") or ("6381100") or ("6484045") or ("6809653") or ("20030088166") or ("20050277164") or ("20060063351") or ("20060006792") or ("20040075628") or ("20020186208") or ("5635767") or ("6175160") or ("5640049") or ("5473120") or ("6847527") or ("6150726") or ("6661024")).PN.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/09/21 11:32
S82	313	S81 and S76 and S77 and S78	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 12:41
S81	65545	S80 with S79	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 12:41
S80	793403	polyimide polyamide thermo\$plastic	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 12:41
S79	1318680	adhere adhesive	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 12:41
S78	551498	wiring .	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 12:41
S77	24648	MCM (multi near chip near module) (multi\$1chip near module) (multi\$1chip\$1module)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 12:41

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S76	1356317	flexible	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/21 12:41
S83	851636	hitachi.as.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/24 11:47
S1	2711	(257/678).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/24 11:47
S87	6495 ,	S86 and S83	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/24 11:48
S86	383672	S84 S85	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/24 11:48
S85	288326	three\$1dimension\$4 three-dimension\$4	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/24 11:48
S84	383332	three near dimension\$4	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/24 11:48
S88	472405	thermo\$1plastic	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/24 11:49
S90	4088	S83 and S88	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/24 11:55
S89	105	S87 and S88	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/24 11:55
S91	947	S90 and (package packaging adhesive)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/24 11:56

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S92	243	S90 and (package packaging) and adhesive	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/24 14:19
S95	6	S93 S94	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/24 14:23
S94	4	(("6693162") or ("5621068")).PN.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/24 14:23
S93	4	(("5668247") or ("5621068")).PN.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/24 14:23
S96	2	"US 20060049495"	US-PGPUB; USPAT; USOCR; DERWENT	OR	ON	2006/10/24 15:17
S97	2	("6809412").PN.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/24 16:53
S98	472405	thermo\$1plastic	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/25 09:22
L2	136	("3039177" "3467892" "4628408" "4833568" "5289346"). PN. OR ("5394303").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/10/25 09:22
L1	2	("5394303").PN.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/25 09:22
L4	55	2 and (L3 polyimide)	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/25 09:24
L3	472405	thermo\$1plastic	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/10/25 09:24